



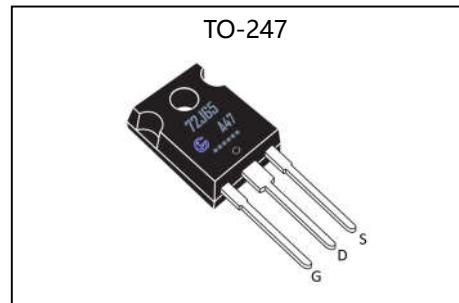
GL72J65A47

GL Silicon N-Channel Super-Junction Power MOSFET

General Description

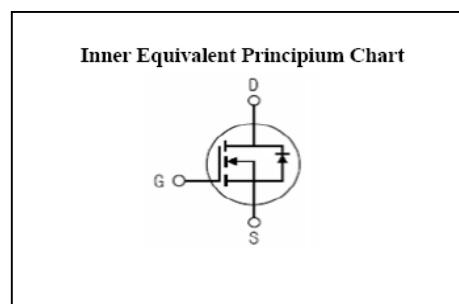
GL72J65A47 is the silicon N-channel Enhanced VDMOSFETS, is obtained by the self-aligned Super-junction Technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. The transistor can be used in various power switching circuit for system miniaturization and higher efficiency. The package form is TO-247, which accords with the RoHS standard.

V_{DSS}	650	V
I_D	72	A
$P_D(T_C=25^\circ\text{C})$	500	W
$R_{DS(\text{ON})\text{TYP}}$	38	$\text{m}\Omega$



Features

- Fast Switching
- Low Gate Charge and $R_{DS(\text{ON})}$
- Low Reverse transfer capacitances
- 100% Single Pulse avalanche energy Test



Applications

- Switch Mode Power Supply(SMPS)
- Uninterruptible Power Supply(UPS)
- Power Factor Correction(PFC)

Absolute ($T_C = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Rating	Units
V_{DSS}	Drain-to-Source Voltage	650	V
I_D	Continuous Drain Current	72	A
I_{DM}^{a1}	Pulsed Drain Current	216	A
V_{GS}	Gate-to-Source Voltage	± 30	V
E_{AS}^{a2}	Single Pulse Avalanche Energy	2200	mJ
P_D	Power Dissipation	500	W
T_J, T_{stg}	Operating Junction and Storage Temperature Range	150, -55 to 150	$^\circ\text{C}$
T_L	Maximum Temperature for Soldering	300	$^\circ\text{C}$

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device.

Thermal Characteristics

Symbol	Parameter	Typ.	Units
$R_{\theta JC}$	Junction-to-Case	0.25	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Junction-to-Ambient	55	$^\circ\text{C}/\text{W}$



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Electrical Characteristics ($T_c = 25^\circ\text{C}$ unless otherwise specified)

OFF Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
V_{DSS}	Drain to Source Breakdown Voltage	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	650	--	--	V
I_{DSS}	Drain to Source Leakage Current	$V_{DS}=650\text{V}, V_{GS}=0\text{V}, T_a=25^\circ\text{C}$	--	--	10	μA
		$V_{DS}=520\text{V}, V_{GS}=0\text{V}, T_a=150^\circ\text{C}$	--	--	1000	
$I_{GSS(F)}$	Gate to Source Forward Leakage	$V_{GS}=+30\text{V}$	--	--	100	nA
$I_{GSS(R)}$	Gate to Source Reverse Leakage	$V_{GS}=-30\text{V}$	--	--	-100	nA

ON Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$R_{DS(ON)}^{a3}$	Drain-to-Source On-Resistance	$V_{GS}=10\text{V}, I_D=36\text{A}$	--	38	45	$\text{m}\Omega$
$V_{GS(\text{TH})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	3.0	--	5.0	V

Dynamic Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
g_{fs}^{a3}	Forward Transconductance	$V_{DS}=10\text{V}, I_D=36\text{A}$	--	40	--	S
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_D=25\text{V}$ $f=1.0\text{MHz}$	--	7800	--	pF
C_{oss}	Output Capacitance		--	221	--	
C_{rss}	Reverse Transfer Capacitance		--	13.5	--	

Resistive Switching Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$t_{d(\text{ON})}$	Turn-on Delay Time	$V_{DD}=350\text{V}, I_D=36\text{A},$ $V_{GS}=10\text{V}, R_g=25\Omega$	--	103	--	ns
t_r	Rise Time		--	85	--	
$t_{d(\text{OFF})}$	Turn-Off Delay Time		--	530	--	
t_f	Fall Time		--	90	--	
Q_g	Total Gate Charge	$V_{DD}=350\text{V}, I_D=36\text{A}$ $V_{GS}=0 \text{ to } 10\text{V}$	--	160	--	nC
Q_{gs}	Gate to Source Charge		--	45	--	
Q_{gd}	Gate to Drain ("Miller")Charge		--	60	--	



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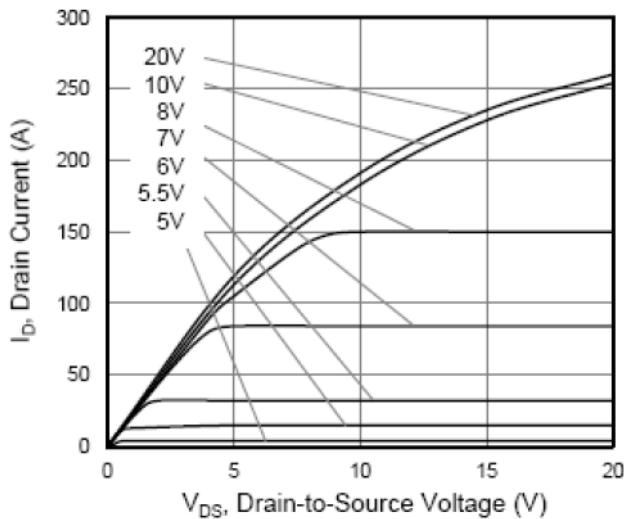
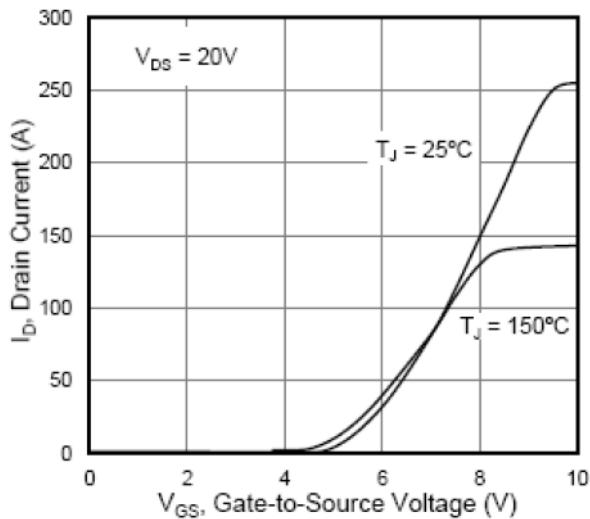
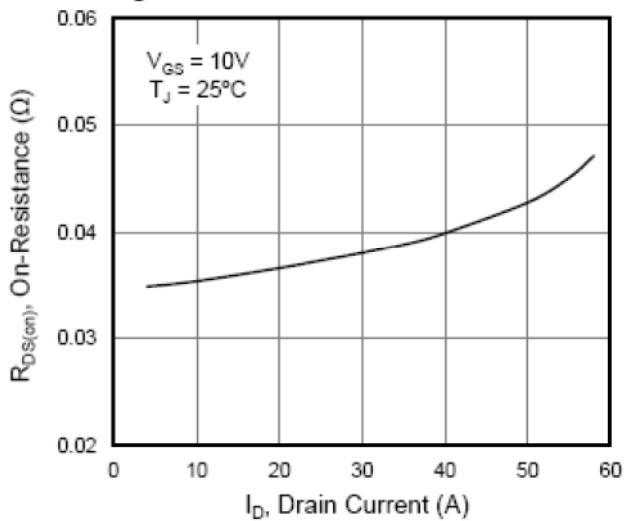
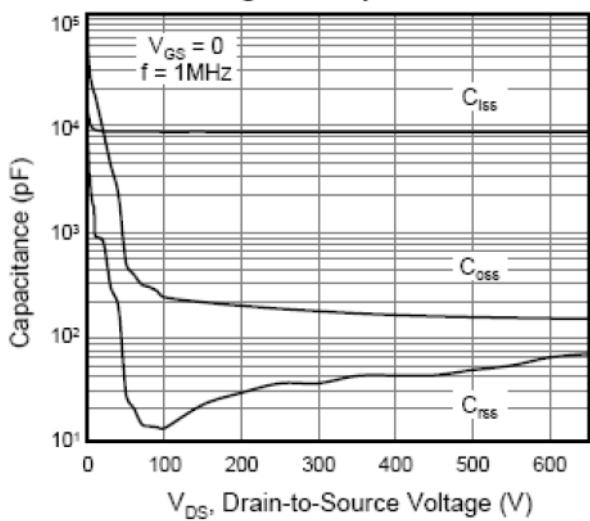
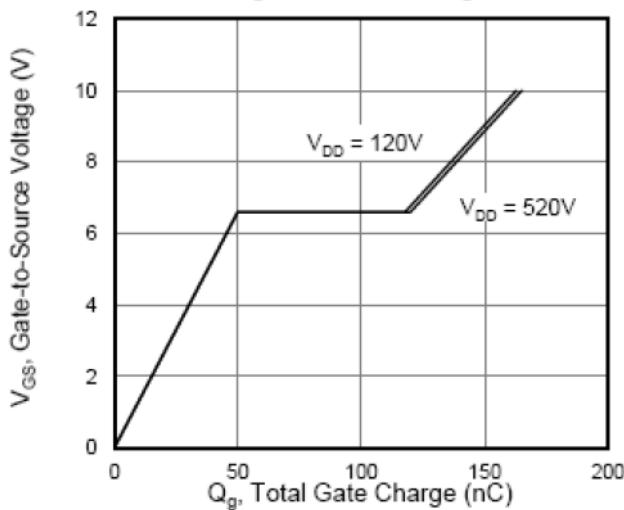
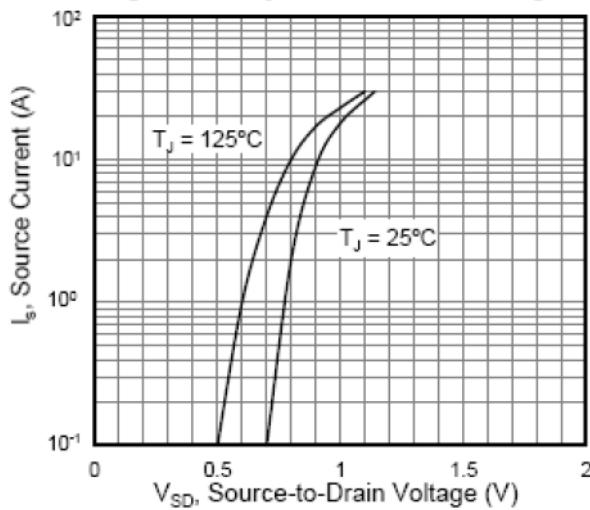
Source-Drain Diode Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
I _S	Continuous Source Current (Body Diode)		--	--	72	A
I _{SM}	Maximum Pulsed Current (Body Diode)		--	--	200	A
V _{SD}	Diode Forward Voltage	I _S =72A, V _{GS} =0V	--	--	1.5	V
t _{rr}	Reverse Recovery Time	I _S =72A, V _{GS} =0V	--	280	--	ns
Q _{rr}	Reverse Recovery Charge	I _S =I _F , dI/dt=100A/μs	--	1.5	--	μC

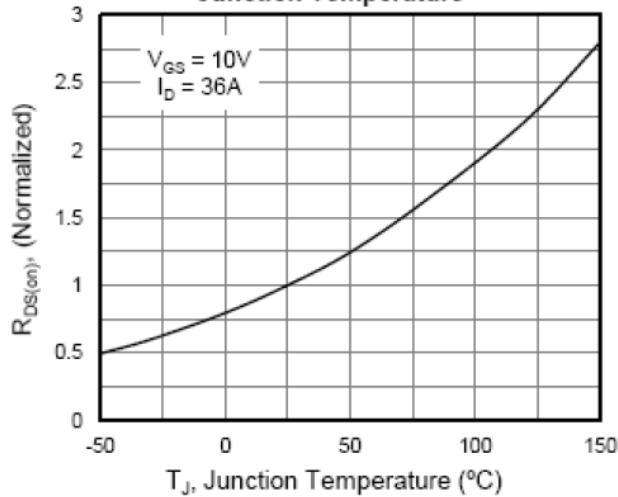
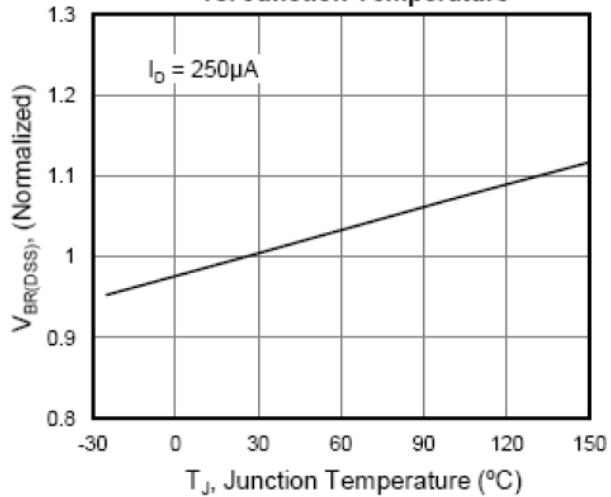
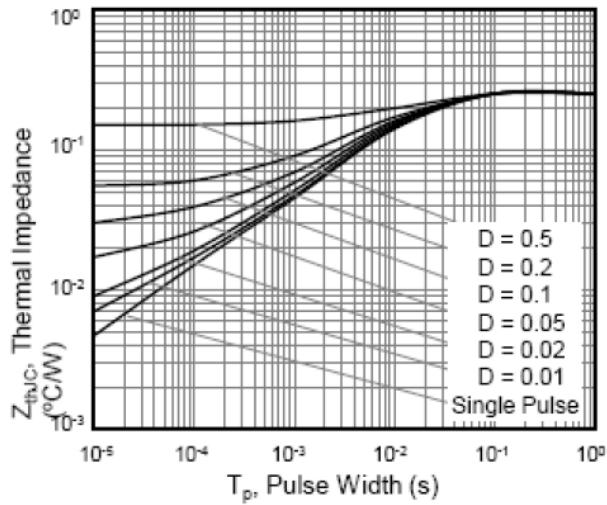
Pulse width tp≤380μs, δ≤2%

a1: Repetitive rating; pulse width limited by maximum junction temperature

a2: I_{AS}=72A, V_{DD}=50V, RG=25Ω, Starting TJ= 25°C

a3: Pulse Test: Pulse width≤380us, Duty Cycle≤2%

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Typical Characteristics
Figure 1. Output Characteristics

Figure 2. Transfer Characteristics

Figure 3. On-Resistance vs. Drain Current

Figure 4. Capacitance

Figure 5. Gate Charge

Figure 6. Body Diode Forward Voltage


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**Figure 7. On-Resistance vs.
Junction Temperature**

**Figure 8. Breakdown voltage
vs. Junction Temperature**

**Figure 9 . Transient Thermal Impedance for
TO-247**

**Figure 10. Safe operation area for
TO-247**
